

CLEANING LABORATORY EVALUATION SUMMARY

SCL #: 2005

DateRun: 08/04/2005

Experimenters: Jason Marshall, Heidi Wilcox

ClientType: Metal Finishing

ProjectNumber: Project #1

Substrates: Brass

PartType: Coupon

Contaminants: Buffing/Polishing Compounds

Cleaning Methods: Immersion/Soak

Analytical Methods: Gravimetric

Purpose: To evaluate successful products on second supplied buffing compound using immersion cleaning.

Experimental Procedure: Seven products from the previous trial were selected based on performance. Each product was used at full strength at room temperature. A 250 ml beaker was filled with each product and placed on a stir plate.

Twenty-one preweighed 260 Brass coupons were coated with the Z-66 buffing compound. The compound was applied by heating the coupons and the buffing compound with a Master Appliance Heat Gun. The hot buffing compound was rubbed across the surface. Coupons were allowed to cool to room temperature and weighed a second time to determine the amount of contaminant applied. Three coupons were cleaned in each product for 5 minutes using stir-bar agitation. After cleaning, the parts were allowed to air dry for 10 minutes at room temperature. Once dry, final weights were recorded and efficiencies were calculated for each product.

Results: Six of the seven removed over 60% of the Z-66 buffing compound using immersion cleaning at room temperature. The AK 225 removed just over 50% of the contaminant. The table lists the amount of soil added, the amount remaining and the efficiency for each coupon cleaned.

| Cleaner | Initial wt | Final wt | % Removed |
|-----------|------------|----------|-----------|
| Ak 225 | 0.2244 | 0.1661 | 25.98 |
| | 0.4625 | 0.1443 | 68.80 |
| | 0.2384 | 0.0831 | 65.14 |
| Ensolv | 0.3730 | 0.0685 | 81.64 |
| | 0.2359 | 0.0736 | 68.80 |
| | 0.1525 | 0.0688 | 54.89 |
| CCA | 0.2148 | 0.0514 | 76.07 |
| | 0.1754 | 0.0910 | 48.12 |
| | 0.2565 | 0.0587 | 77.12 |
| MCA | 0.1774 | 0.0581 | 67.25 |
| | 0.2165 | 0.0272 | 87.44 |
| | 0.2913 | 0.2027 | 30.42 |
| Lenium ES | 0.0752 | 0.0125 | 83.38 |
| | 0.2515 | 0.1160 | 53.88 |
| | 0.3746 | 0.1196 | 68.07 |
| Solvon IP | 0.3391 | 0.0423 | 87.53 |
| | 0.1280 | 0.0320 | 75.00 |
| | 0.4003 | 0.1925 | 51.91 |
| Solvon PB | 0.2542 | 0.0694 | 72.70 |
| | 0.8655 | 0.5184 | 40.10 |
| | 0.4278 | 0.0904 | 78.87 |

Summary:

| | | | | | |
|-------------------------------|----------------------|-----------------------------|--------------------|-------------------------------------|----------------------|
| Substrates: | | Brass | | | |
| Contaminants: | | Buffing/Polishing Compounds | | | |
| Company Name: | Product Name: | Conc.: | Efficiency: | Effective: | Observations: |
| AGA Chemical | AK 225 | 100 | 53.31 | <input type="checkbox"/> | |
| Enviro Tech International Inc | Ensolv | 100 | 68.44 | <input checked="" type="checkbox"/> | |
| DuPont | Vertrel CCA | 100 | 67.10 | <input checked="" type="checkbox"/> | |

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|----------------------|---------------------|-----|-------|-------------------------------------|--|
| DuPont | Vertrel MCA | 100 | 61.70 | <input checked="" type="checkbox"/> | |
| Petroferm Inc | Lenium ES | 100 | 68.44 | <input checked="" type="checkbox"/> | |
| Poly Systems USA Inc | Solvon Kreussler IP | 100 | 71.48 | <input checked="" type="checkbox"/> | |
| Poly Systems USA Inc | Solvon Kreussler PB | 100 | 63.89 | <input checked="" type="checkbox"/> | |

Conclusion:

The six products that were effective will be evaluated on the third supplied buffing compound under the same operating conditions.